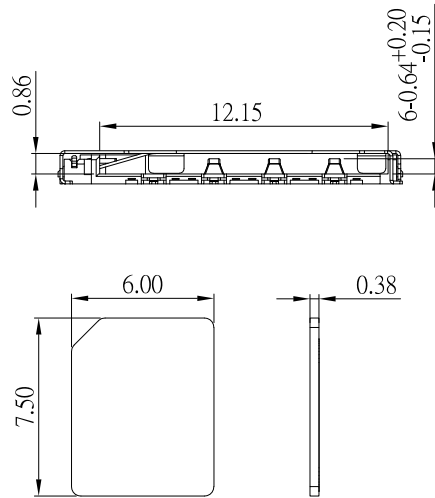
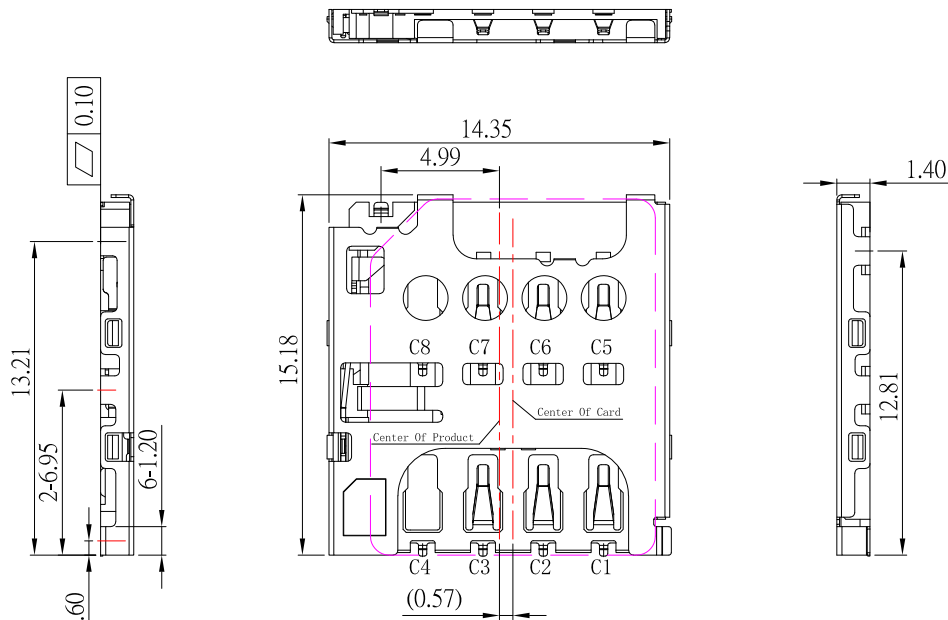
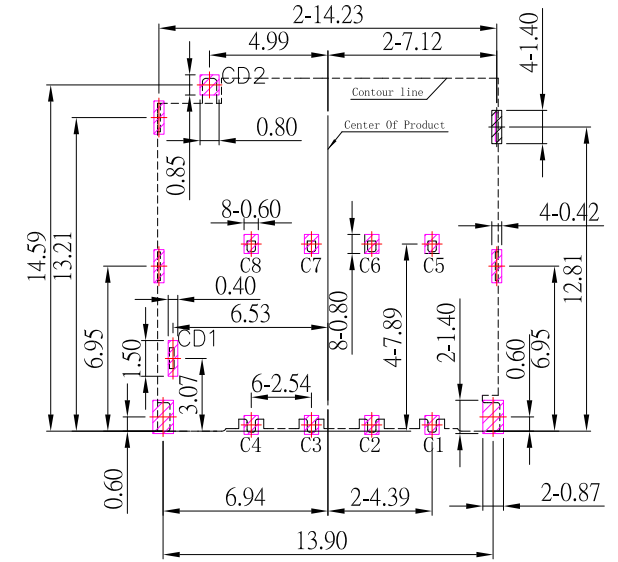
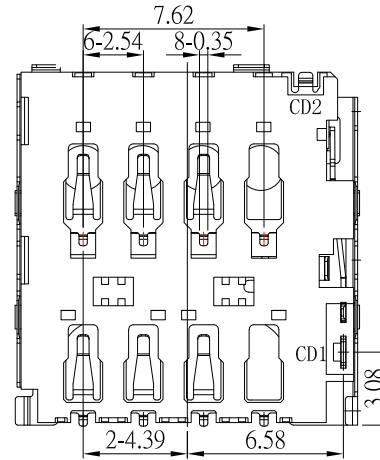
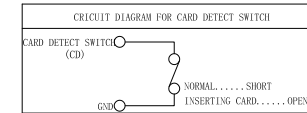




PIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved
CD1	Detect Switch
CD2	Detect Switch



P.C.B LAYOUT



NOTES:

1) MATERIAL:

1.1 HOUSING: LCP

1.2 CONTACT: PHOSPHOR BRONZE

1.3 SHELL: SUS

2) FINISH:

2.1 CONTACT: PLATED GOLD IN MATING AREA ;

GOLD PLATED ON SOLDER BALLS ;

NICKEL UNDER PLATED OVERALL

2.2 SHELL: NICKEL UNDER PLATED SURFACE LAYER

3) ELECTRICAL CHARACTERISTICS

3.1 RATING CURRENT: 0.5 A

3.2 RATING VOLTAGE: 30V DC

3.3 CONTACT RESISTANCE: 100 mΩ MAX

3.4 INSULATION RESISTANCE: 1000MΩ MIN

4.5 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC

4.6 OPERATING TEMPERATURE: -40°C ~ +75°C

 东莞市高迪电子有限公司
DONG GUAN GAO DI ELECTRONICS CO., LTD

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	07/29/25	FINISH	MODLE	MICRO SIM CARD CONNECTOR 8PIN NO-PUSH H1.40mm
CHECKED BY:	DATE	SCALE	DWG NO.	SIZE
Jacky Chen	07/29/25	1 : 1	MSIM-008-S304	A4
APPROVED BY:	DATE	SHEET NO.	PART NO.	VER
Tony Kao	07/29/25	1 of 1	MSIM-008-S304	R

ITEM NO.	DESCRIPTION	DRAWN	DATE
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